

IN THE INTERNATIONAL BUREAU OF WIPO

APPLN. OF: BERG)
APPLN. NO: PCT/US00/02543)
FILED: February 1, 2000)
FOR: Improved Circuit Board Manufacturing Process)
DOCKET: BERG 99.01 CIP PCT)

International Bureau of WIPO
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AMENDMENT OF CLAIMS UNDER ARTICLE 19

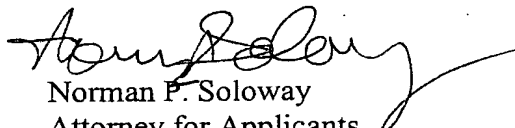
In response to the International Search Report mailed February 26, 2001, please replace claim pages 12-20 with the attached new claim pages.

The claims have been amended to address the objections under PCT Rule 66.2(a)(v). Additionally, claim 1 has been amended to clarify that the second circuit pattern on the bottom surface is different from the first circuit pattern on the top surface. This is nowhere disclosed nor suggested in U.S. Patent 3,795,047 which gratuitously suggests forming conductive strips on both sides of the dielectric material, without suggesting how to avoid short-circuits or cross-talk.

In the event there are any fee deficiencies or additional fees are payable, please charge them to our deposit account number 08-1391.

If there is a problem with this submission, or any further information is required, it is requested that the undersigned attorney be contacted by collect telephone call.

RESPECTFULLY SUBMITTED


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